

## 75343G-VB Datasheet N-Channel 60 V (D-S) MOSFET

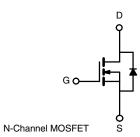
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.007			
I <sub>D</sub> (A)	150			
Configuration	Single			
Package	TO-247			

#### FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- 100 %  $\rm R_g$  and UIS tested







<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V <sub>DS</sub>	60	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20	v			
Continuous Drain Current	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	150			
Continuous Drain Current	T <sub>C</sub> = 125 °C		88			
Continuous Source Current (Diode Conduc	I <sub>S</sub>	120	А			
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	480				
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	65			
Single Pulse Avalanche Energy	L = 0.1 MH	E <sub>AS</sub>	211	mJ		
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	P	175	W		
Maximum Fower Dissipation 5	T <sub>C</sub> = 125 °C	P <sub>D</sub>	56	vv		
Operating Junction and Storage Temperatu	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C			

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	LIMIT	UNIT			
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	40	°C/W			
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.88	0/11			

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		1			1	1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		60	-	-	v
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.5	3.0	3.5	v
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS} = \pm 20$ V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 125 °C	-	-	50	μΑ
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 175 °C	-	-	250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	120	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A	-	0.007	-	Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C	-	0.010	-	
		$V_{GS} = 10 V$	I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C	-	0.013	-	
Forward Transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		94	-	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			-	5196	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{DS} = 25 V$ , f = 1 MHz	-	710	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	7		-	340	-	
Total Gate Charge <sup>c</sup>	Qg			-	97	-	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 30 \text{ V}, I_D = 75 \text{ A}$	-	24.6	-	nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	27.2	-	
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.3	1	1.7	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>				16	24	
Rise Time <sup>c</sup>	t <sub>r</sub>	$\begin{array}{l} V_{\text{DD}}=30 \text{ V}, \ R_{\text{L}}=0.4 \ \Omega\\ I_{\text{D}}\cong75 \text{ A}, \ V_{\text{GEN}}=10 \text{ V}, \ R_{\text{g}}=1 \ \Omega \end{array}$		-	14	21	- ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	34	51	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	9	14	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>					·	
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	480	Α
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 75 A, V <sub>GS</sub> = 0		-	0.9	1.5	V

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

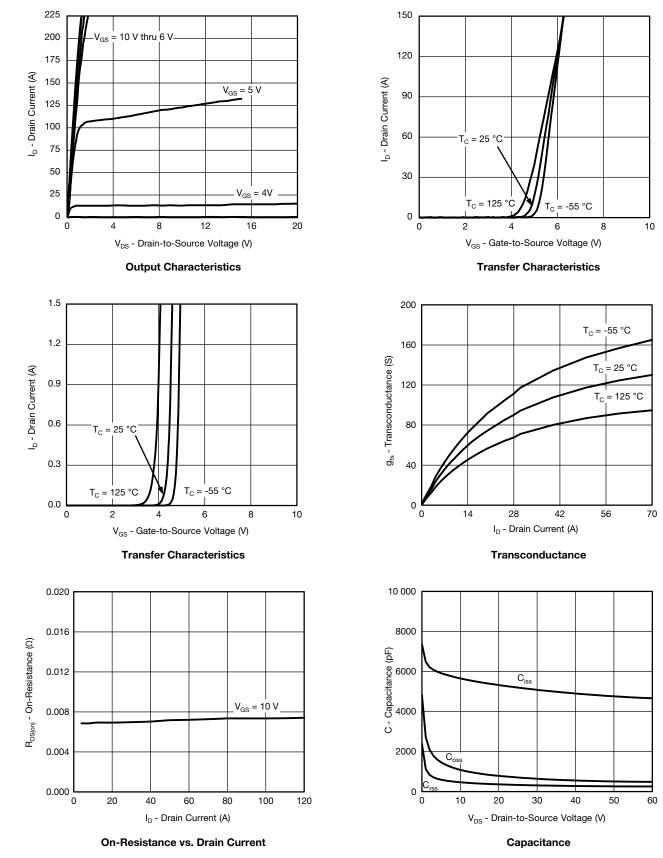
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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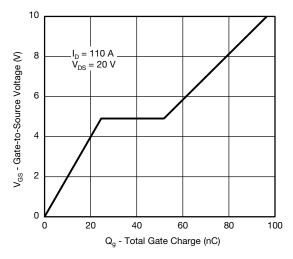
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



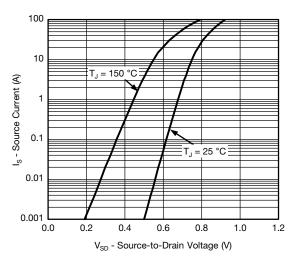
服务热线:400-655-8788



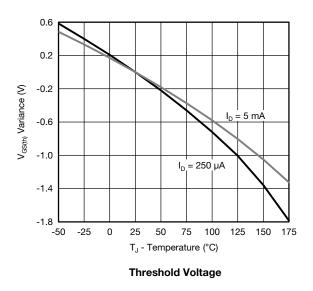
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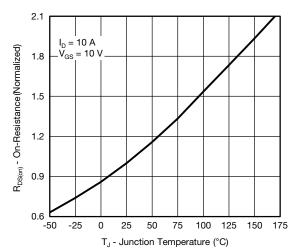


Gate Charge

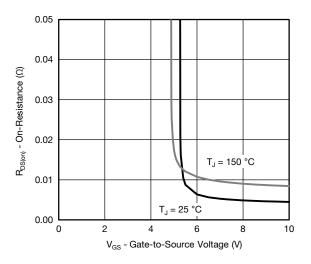


Source Drain Diode Forward Voltage

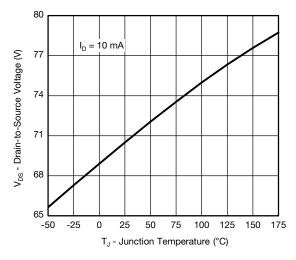


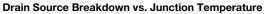


**On-Resistance vs. Junction Temperature** 



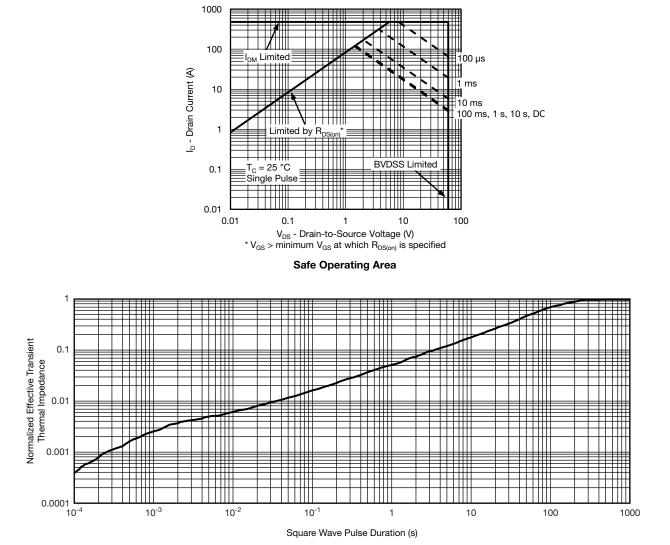
On-Resistance vs. Gate-to-Source Voltage







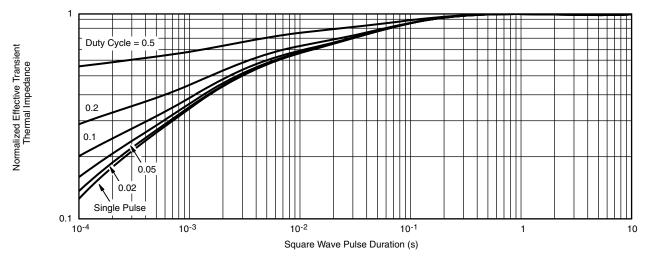
#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

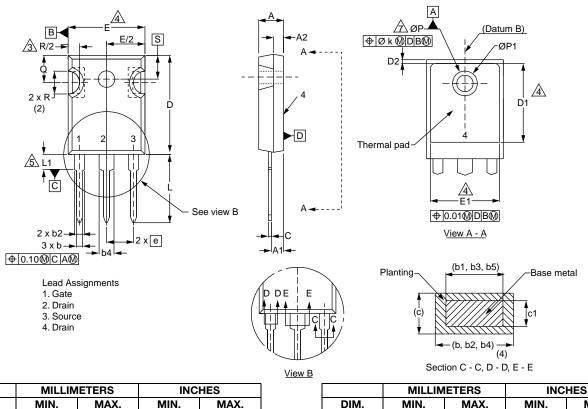
#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



**TO-247AC** 



	MILLIN	IETERS	INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	
А	4.58	5.31	0.180	0.209	D2	
A1	2.21	2.59	0.087	0.102	E	
A2	1.17	2.49	0.046	0.098	E1	
b	0.99	1.40	0.039	0.055	е	
b1	0.99	1.35	0.039	0.053	Øk	
b2	1.53	2.39	0.060	0.094	L	
b3	1.65	2.37	0.065	0.093	L1	
b4	2.42	3.43	0.095	0.135	N	
b5	2.59	3.38	0.102	0.133	ØР	
С	0.38	0.86	0.015	0.034	Ø P1	
c1	0.38	0.76	0.015	0.030	Q	
D	19.71	20.82	0.776	0.820	R	
D1	13.08	-	0.515	-	S	

	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
E	15.29	15.87	0.602	0.625
E1	13.72	-	0.540	-
е	5.46	BSC	0.215	BSC
Øk	0.254		0.0	)10
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
N	7.62	BSC	0.300	BSC
ØР	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51	BSC	0.217	BSC



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